

## **CB71**

# RUGGED COM EXPRESS MODULE WITH AMD RYZEN EMBEDDED



- AMD Ryzen Embedded V1000/R1000 APU
- Up to 32 GB DDR4 RAM with ECC
- Up to 4 Digital Display Interfaces (DP, eDP, HDMI, DVI)
- Hardware memory encryption
- Board management controller with safetyrelated supervision functions
- Virtualization-ready
- Excellent price-performance ratio
- -40 °C to +85 °C Tcase, depending on processor
- Conduction cooling
- Compliant with COM Express Basic, type 6
- PICMG COM.0 and Ultra-Rugged COM versions



#### TRULY RUGGED COM EXPRESS MODULE

The CB71 is a rugged COM Express module with Type 6 Pin-Out for demanding applications in the railway, public transportation and industrial markets. Its high-performance features match the requirements of applications like data acquisition, infotainment, transcoding or live 3D. The rugged CB71 is designed for operation from -40 °C to +85 °C. To withstand serious shock and vibration, only soldered-down components are used. The design is optimized for conformal coating.

#### ALSO FOR EXTREMELY HARSH ENVIRONMENTS

For applications that need reliable operation even under the harshest environmental conditions, a specially hardened version is available - the CB71C. CB71C modules are embedded in a closed aluminum frame that ensures optimum EMC protection and efficient conduction cooling. Direct air cooling is possible by placing a heat sink on the cover. The innovative mechanical design around the COM.0 electronics makes it an ultra-rugged module.

## POWERFUL PROCESSING AND GRAPHICS ON A SINGLE CHIP

The CB71 is based on the AMD Ryzen Embedded V1000/R1000 APU family. It comes with a Radeon Vega next-generation 3D graphics engine and supports up to four displays with up to 4k resolution, without the need for additional graphics hardware. With two (R1000) or four (V1000) high-performance processor cores and AMD-V extension, the CB71 is also suitable for virtualization.

#### **EXCELLENT PRICE/PERFORMANCE & FLEXIBILITY**

The CB71 can be equipped with an R1000 dual-core APU or a V1000 quad-core APU offering long-term availability and scalable performance and supporting ECC. Passive cooling is possible with low-power versions.

#### **SAFETY AND SECURITY**

The board management controller has supervision functions (onboard voltages, temperature etc.) that make the board suitable for safety-related applications. In addition, the CB71 has a Trusted Platform Module and supports hardware memory encryption, providing protection against both physical and inter-VM storage attacks. This is essential for security-critical applications such as payment and ticketing terminals, fleet management or monitoring.

#### **MEMORY AND I/O**

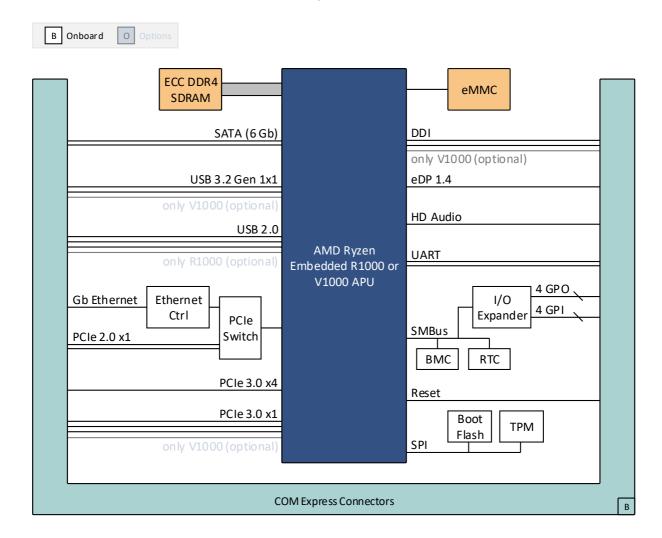
The CB71 can be equipped with up to 32 GB of directly soldered DDR4 main memory and up to 64 GB eMMC. Available high-speed interfaces include PCI Express 3.0 links, DDI (DP, eDP, HDMI), SATA 3.0, Gigabit Ethernet and USB 3.2 Gen 1x1.



www.duagon.com/products/cb71/

**DATA SHEET** 

## CB71 | DIAGRAM



## **CB71 | TECHNICAL DATA**

#### **CPU**

- The following CPU types are supported:
  - AMD V1404I, 4 cores, 8 threads, 2.0 GHz base, 12-25 W, 2 MB cache, Vega GPU with 8 CUs, iTemp
  - AMD V1807B, 4 cores, 8 threads, 3.35 GHz, 35-54 W,
     2 MB cache, Vega GPU with 11 CUs
  - AMD R1606G, 2 cores, 4 threads, 2.6 GHz, 12-25 W, 1 MB cache, Vega GPU with 3 CUs

#### **MEMORY**

- System RAM
  - Soldered DDR4, ECC
  - 32 GB max.

## **SECURITY**

Trusted Platform Module 2.0

#### **MASS STORAGE**

eMMC (soldered); 16 GB

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#### **GRAPHICS**

- Processor graphics
- Maximum resolution: 4096 × 2160 pixels @ 60 Hz, 36 bpp

#### **INTERFACES**

- This product includes interface options
  - Available interfaces depend on the processor type
- SATA
  - 2 × SATA Revision 3.x, board to board
- Video
  - 3 × DDI, board to board
  - 1 × eDP 1.4, board to board
- Audio
  - 1 × board to board
  - HD Audio
- USB
  - 3 × USB 3.2 Gen 1x1, board to board
  - 3 × USB 2.0, board to board
- Ethernet
  - 1 × 10/100/1000BASE-T, board to board
- PCI Express
  - 1 × PCle 3.0, x4, board to board
  - 4 × PCle 3.0, x1, board to board
  - 2 × PCIe 2.0, x1, board to board
- Serial
  - 2 × UART, board to board
  - Physical interfaces, e.g., RS232 or RS422/RS485, depending on implementation on carrier board
- GPIO
  - 4 × GPI non-isolated, board to board
  - 4 × GPO non-isolated, board to board
- SMB
  - 1 × board to board
- Reset
  - 1 × board to board

#### SUPERVISION AND CONTROL

- Board management controller
- Temperature measurement
- Watchdog timer
- Real-time clock

#### **PRODUCT STANDARD**

- Basic, Type 6, PICMG COM.0 COM Express Module Base Specification
- Basic, Type 6, Ultra-Rugged COM

#### **ELECTRICAL SPECIFICATIONS**

- Supply voltage: +12 V (9.5 V to 15.5 V)
- Power consumption: 6 W to 65 W max., depending on processor type and load

#### **MECHANICAL SPECIFICATIONS**

- Dimensions
  - COM Express Basic: (W) 125 mm, (D) 95 mm
  - Ultra-Rugged COM Basic with cover and frame: (W)
     135 mm, (D) 105 mm, (H) 18 mm
- Weight: 70 g (COM Express model 15CB71-00); 480 g (Ultra-Rugged COM models, approx.)
- Cooling: Conduction cooling

#### PRODUCT COMPLIANCE: RAIL - ROLLING STOCK

- Compliance level: This product is prepared for use in EN 50155:2017 systems. Some parameters are systemdependent and are specified on system level.
- Operating temperature: -40 °C to +85 °C (EN 50155:2017, Tmax/PCB = +85 °C; designed for use in OT4+ST1 systems)
- Rapid temperature variations: EN 50155:2017, class H1, no requirements
- Storage temperature: -40 °C (EN 50155:2017) to +85 °C (EN 60068-2-2, Bb)
- Altitude: +3000 m max. (EN 50125-1:2014, class AX)
- Pollution degree: EN 50124-1:2017, class PD2
- Humidity: +55 °C and +25 °C, 100 % RH max. (EN 50155:2017)
- Shock: 30 ms @ 50 m/s² (EN 61373:2010/AC:2017-09, vehicle body, cat. 1, class B)

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- Vibration: 10 min @ 2.02 m/s² (functional) and 5 h @ 11.44 m/s² (long-life) (EN 61373:2010/AC:2017-09, vehicle body, cat. 1, class B x 2)
- Electrical safety
  - EN 50155:2017
  - EN 50153:2014 + A1:2017
  - EN 50124-1:2017
- Fire protection: EN 45545-2:2013 + A1:2015, HL3
- EMC emission: EN 50121-3-2:2016
- EMC immunity: EN 50121-3-2:2016
- Protective coatings: EN 50155:2017, class PCX (As agreed between user and supplier)
- Useful life: 20 years (EN 50155:2017, class L4)

#### PRODUCT COMPLIANCE: ROAD VEHICLE

- EMC emission: ECE R10 Rev.5
- EMC immunity: ECE R10 Rev.5

#### **RELIABILITY**

 MTBF: 363 958 h predicted @ 40 °C according to IEC/TR 62380 (RDF 2000) (model 15CB71C00)

## **BIOS/BOOT LOADER**

AMI Aptio UEFI Firmware

#### **SOFTWARE SUPPORT**

- Linux
  - Supported kernel: 4.14.71
  - Driver support
  - Tool support
  - Yocto BSP
  - Tested with: Yocto BSP (Sumo 2.5, Linux kernel 4.14.71)
- Windows
  - Windows 10 IoT Enterprise 64-bit
  - Driver support
  - Tool support
  - Not all functions are supported
- See the product User Manual for details on software support: www.duagon.com/products/cb71/#doc
- See also Application Note Recommendations for a Robust Software Setup
- See section Software on the product web page for available packages: www.duagon.com/products/cb71/#downl

## **CB71 | ORDERING INFORMATION**

## **STANDARD MODELS**

15CB71-00 COM Express "Basic", type 6, AMD V1404I, 2 GHz, 16 GB RAM, 3x USB 3.1, 3x USB 2.0, 1x PCle x4, 6x PCle x1, -40 °C to +75 °C (10 min +85 °C), without conduction cooling frame

15CB71C00 Ultra-Rugged COM Express "Basic", type 6, AMD V1807B, 3.35 GHz, 32 GB RAM, 3x USB 3.1, 3x USB 2.0, 1x PCle x4, 6x PCle x1, -40 °C to +85 °C Tcase, with conduction cooling frame

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